POLYCHAR 19 World Forum on Advanced Materials

Kathmandu, the POLYCHAR 19 host city, is situated in a valley full of ancient temples, arts, and impressive architecture. Tribhuvan International Airport in Kathmandu is connected to many major cities of the world. Transport for the participants to and from the conference centre will be provided.

During and after the conference, excursions in and around Kathmandu will be organized. POLYCHAR 19 participants will be offered the opportunity to enjoy the natural beauty of the country during pre- and post conference tours. Upon request, the tours outside Kathmandu (e.g. to Pokhara, Chitwan National Park, Lumbini etc.) will be arranged.

POLYCHAR Scientific Committee has 53 countries represented: http://www.unt.edu/POLYCHAR/sci_comm.html

Welcome to Kathmandu. Let us make POLYCHAR 19 a great success - and also strengthen Materials Research in Nepal.



WORLD FORUM ON ADVANCED MATERIALS

IUPAC Sponsored Conference

First Circular





March 20 - 24, 2011, Kathmandu, NEPAL

Including one day Course on *Polymer Characterisation* (March 20, 2011)



General Information

POLYCHAR belongs to a series of prestigious annual conferences taking place in different countries: http://www.unt.edu/POLYCHAR/. The Forum provides a platform for presentation of innovations in Materials Science and Engineering (MSE) from academia (including students) and industry. Earlier conferences in this series were held in USA (up to 2003), Portugal (2004), Singapore (2005), Japan (2006), Brazil (2007), India (2008), France (2009) and Germany (2010).

The technical programme of **POLYCHAR 19** will comprise oral presentations and poster sessions providing a survey of recent developments in MSE. Conference proceedings will not be printed but there is an opportunity to publish refereed papers in *Polymer Engineering & Science* and in *Macromolecular Symposia*.

SCIENTIFIC PROGRAMME

Symposia Topics

- Predictive methods and simulations
- Nanomaterials and smart materials
- Electrical and dielectric properties
- Mechanical properties and performance
- Rheology and processing
- Structure-property relationships
- Materials synthesis
- Biomaterials, green materials and composites
- Materials for energy and recycling

AWARDS

The prestigious Paul J. Flory Research Prize, International Materials Science Prize and prizes for Young Scientists and Best Poster presenters will be awarded on the last day.

We cordially invite you to submit a contribution (oral or poster) for POLYCHAR 19 and look forward to welcoming you in Kathmandu in March 2011. Please kindly inform your colleagues, co-workers and students about this meeting.

Rameshwar Adhikari POLYCHAR 19 Convener

Organization

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IMPORTANT DEADLINES

Pre-registration	August 30,	2010
Abstract submission	October 15,	2010
Abstract acceptance	November 15,	2010
Registration fee payment	January 15,	2011

REGISTRATION FEES

Conference

Participant .	From SAARC	From Non -
Category	Countries	SAARC Countries
Student	Rs. 2000	Euro 200
Regular	Rs. 3500	Euro 350
Young Scientist	Rs. 3000	Euro 300
Exhibitor	Rs. 20000	Euro 700
Accompanying	Rs. 2000	Euro 200
person		

Course only (Free for lecturers and Forum participants)

Students	Rs. 1000	Euro	50
Course only	Rs. 2000	Euro	100

In case of registration fees payment after January 15, the fees will increase by 20 %.

SUBMISSION OF ABSTRACTS AND ONLINE REGISTRATION

For a sample abstract see http://www.unt.edu/POLYCHAR/sampl_ab.html. For instructions on registration, technical programme and further information please visit the conference website: http://www.polychar19.com

MATERIALS EDUCATION SYMPOSIUM will take place at the Indian Institute of Science, Education and Research in Pune, INDIA after POLYCHAR 19 on March 26-28, 2011. The papers presented there will be considered for refereed publication in the *Journal of Materials Education*. For Participation in this symposium please write to Prof. R. P. Singh:

E-mail: singh.prakash.ram@gmail.com